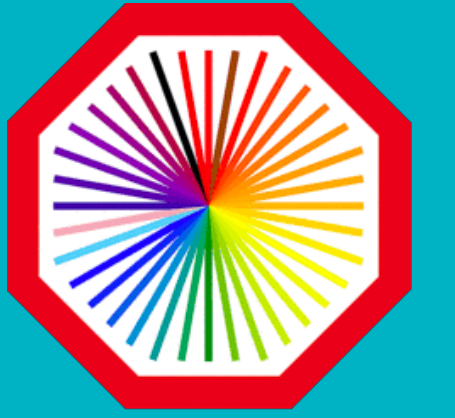


# FASTTRACK DAQ and ALICE in The Netherlands



ALICE



Nikhef





A common DAQ group





# netFELIX: An international collaboration for a Common DAQ

Building a common readout platform was in the air for quite some time

Many discussions took place:

- BNL, IN2P3, Nikhef
- ALICE, ATLAS, LHCb, SHiP, SME
- CERN EP ESE, DT&Head Office
- R&D : DRD 7.1,7.3,7.5 ; CERN EP RnD WP6&9

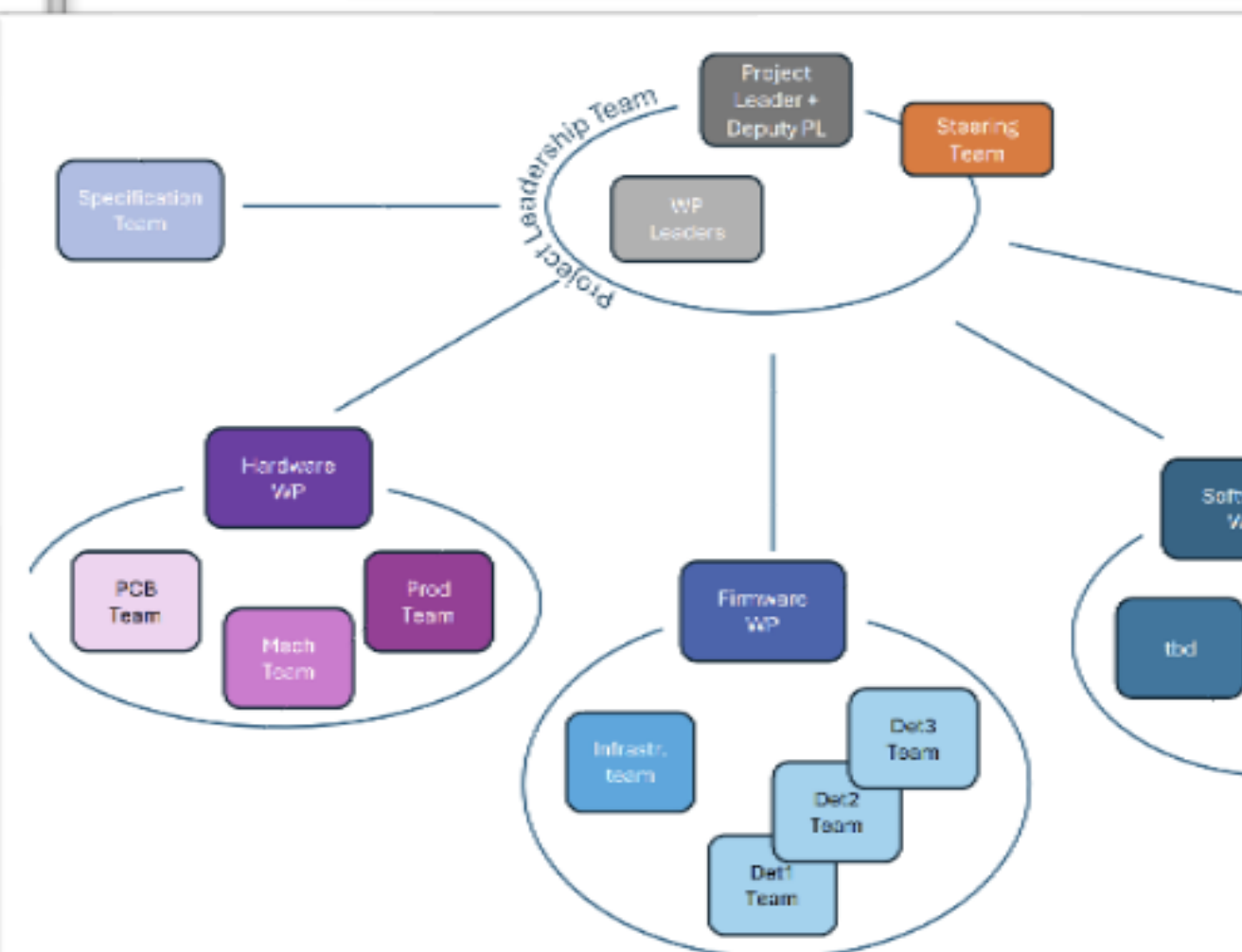
Finally, planets were aligned!

A common Readout Platform for future Experiments designed as an evolution of the ATLAS FLX-155 card, optimized for timing, targeting 400 GbE links to DAQ, future-proof form factor, compatible with lpGBT and Silicon Photonics Front End links.

## netFELIX Kick-Off Meeting

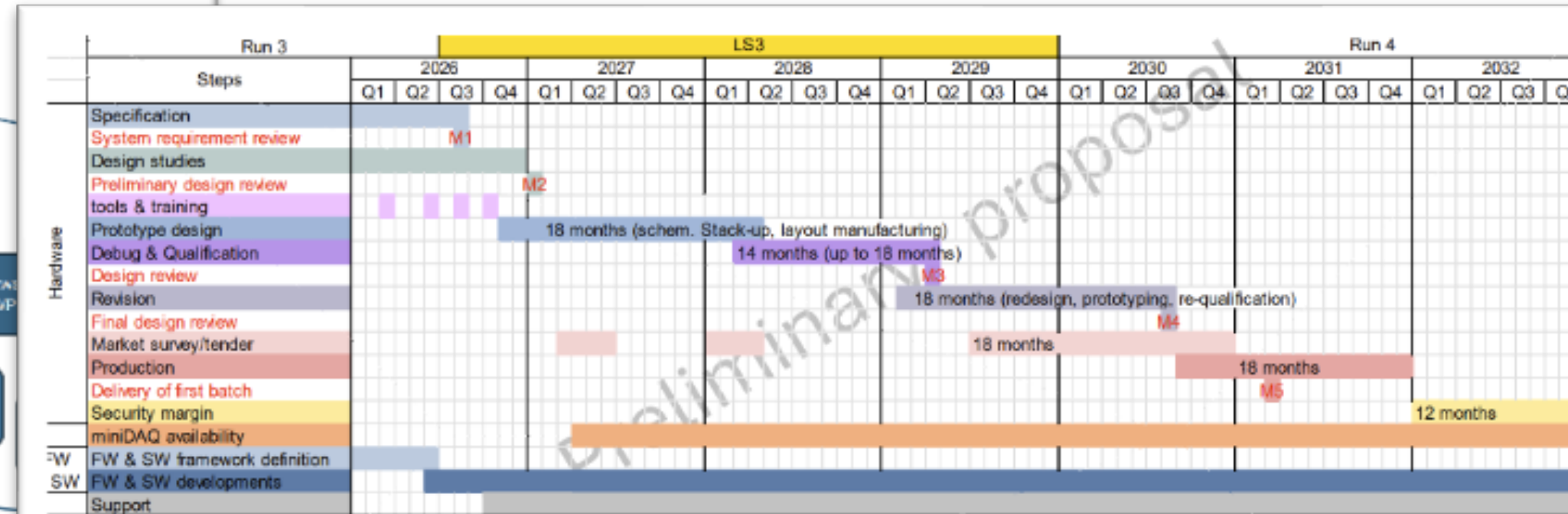
- 4:00 → 14:10 Introduction, Rationale and Motivation  
Speaker: Sophie Baron (cern)  
netFELIX Kick-Off...
- 4:15 → 14:25 Input from Experts (1/4): ATLAS FELIX in a 1U chassis for miniDAQ purposes  
Speaker: Hao Xu (Brookhaven National Laboratory (BNL))  
FELIXin1UChassi...
- 4:30 → 14:40 Input from Experts (2/4): Experience from the ATLAS FELIX firmware development  
Speaker: Frans Schreuder (nikhef national institute for subatomic physics (Nikhef))  
NetFELIXkickoff...
- 4:45 → 14:55 Input from Experts (3/4): Advantages of an Ethernet-based topology  
Speaker: Tommaso Colombo (cern)  
20260121.netfelix...
- 5:00 → 15:10 Input from Experts (4/4): 4x100G links and a White Rabbit node  
experience from the PCIe400 development  
Speaker: Julien Jiro Langouët (axi maxisole ucn, cern/in2p3, cern/axi maxisole, france)  
260121\_400G\_W...

Talk by Frans



### PROPOSAL

- Paschalis Vichoudis / CERN , as Project Leader + HW Team member
- Frans Schreuder / Nikhef, as Deputy Project Leader + FW Team member
- Project Assistant\* (documentation, meeting organization, planning, etc.)



### 2026: preparatory work

- Specification stage
- Studies to validate technical choices
- FW & SW Frameworks preparation

### Important Milestones along the way

- Support to start as soon as miniDAQs available

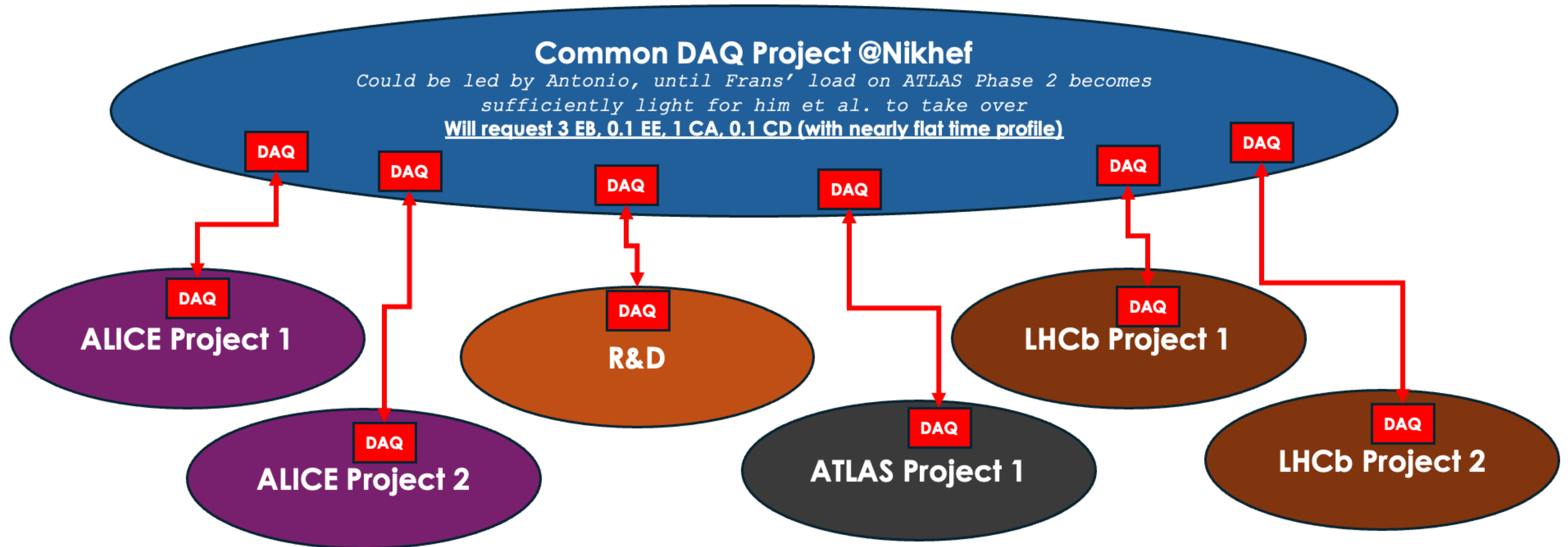
### Component procurement to start after M2

- Especially for critical ones (DDRs, FPGAs..)

### Contingency

- 18 months foreseen for a redesign if needed
- added 2032 as full year of contingency





**N.B. beside the personpower for common DAQ, also some "uncommon" (i.e. project-dependent) DAQ requests, e.g.:**

- 0.x EA (adapter boards, chip carrier boards, etc.)
- 0.x EB (detector specific firmware etc.)
- 0.x EE (test setup cabling etc.)
- 0.x CA (detector-specific embedded software etc.)
- 0.Y CB (control software etc. – this has to be significant)
- 0.x CC (simulation? Not sure what Ruud meant by CC...)





## Common DAQ Project @Nikhef

*Could be led by Antonio, until Frans' load on ATLAS Phase 2 becomes sufficiently light for him et al. to take over*

Will request 3 EB, 0.1 EE, 1 CA, 0.1 CD (with nearly flat time profile)

DAQ

DAQ

DAQ

DAQ

DAQ

DAQ

This, in the coming months, will require coordination and discussion among the different experiments@Nikhef and DAQ group but it can really enhance our reach and visibility in the medium-long term

**N.B. beside the personpower for common DAQ, also some "uncommon" (i.e. project-dependent) DAQ requests, e.g.:**

- 0.x EA (adapter boards, chip carrier boards, etc.)
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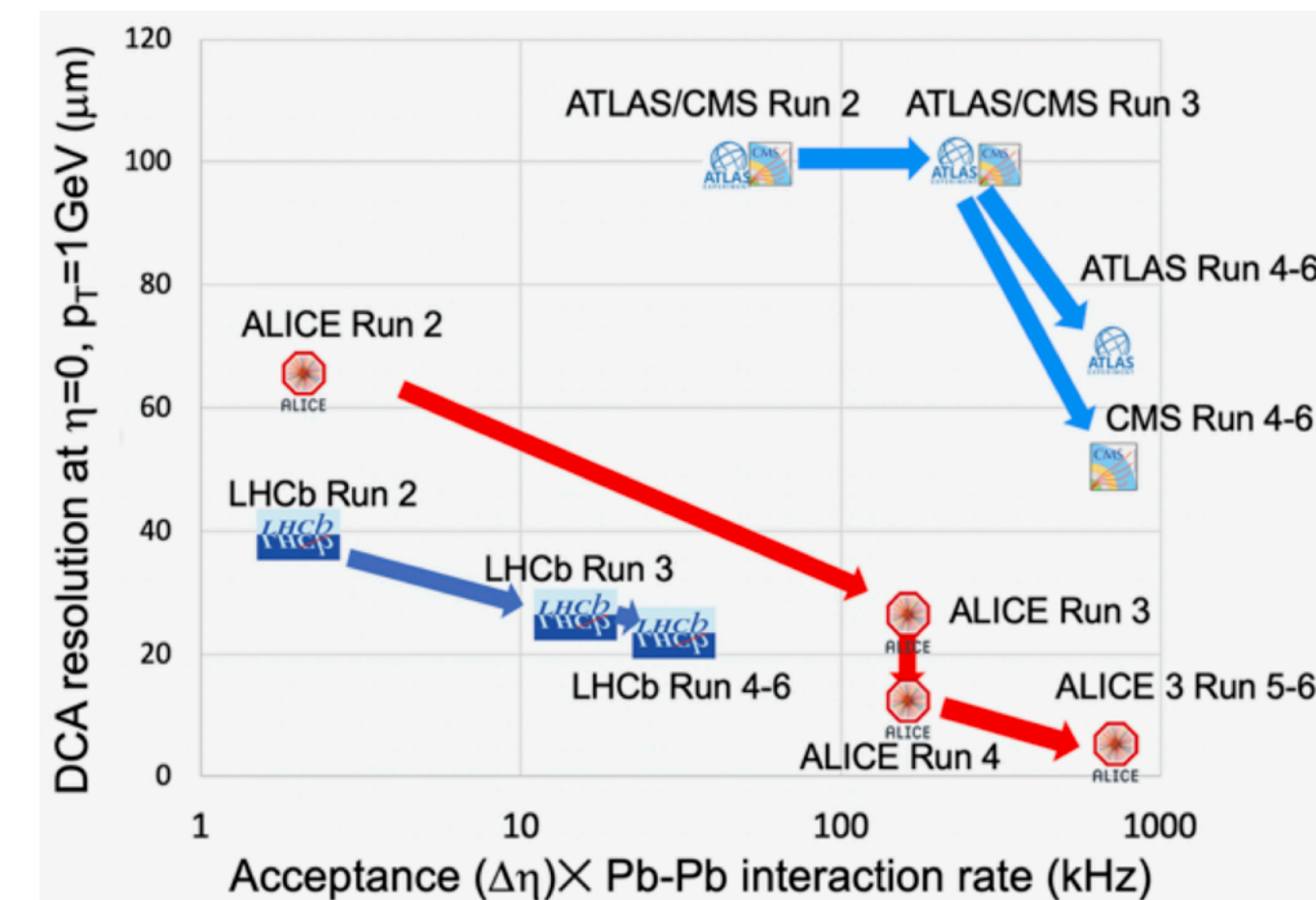
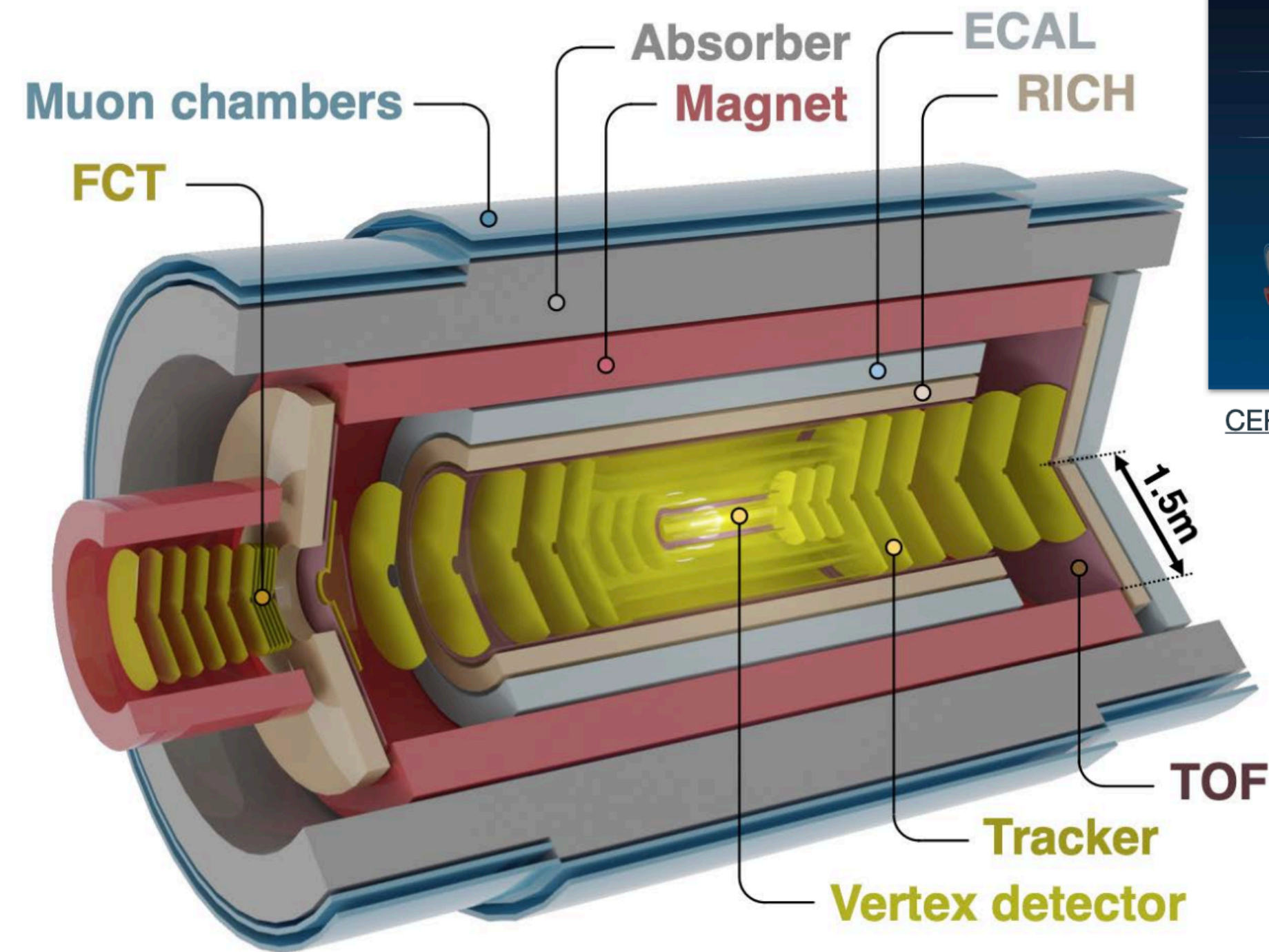




# ALICE3 project(s)



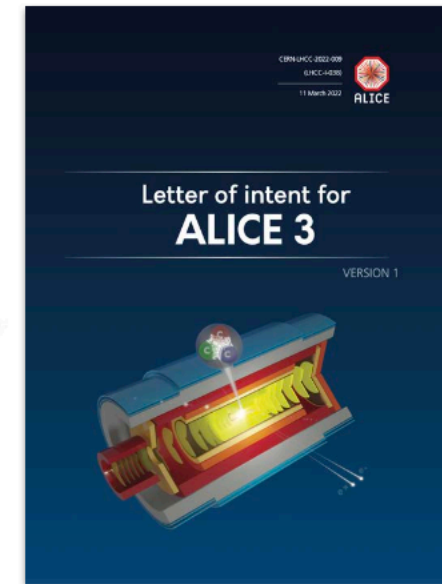
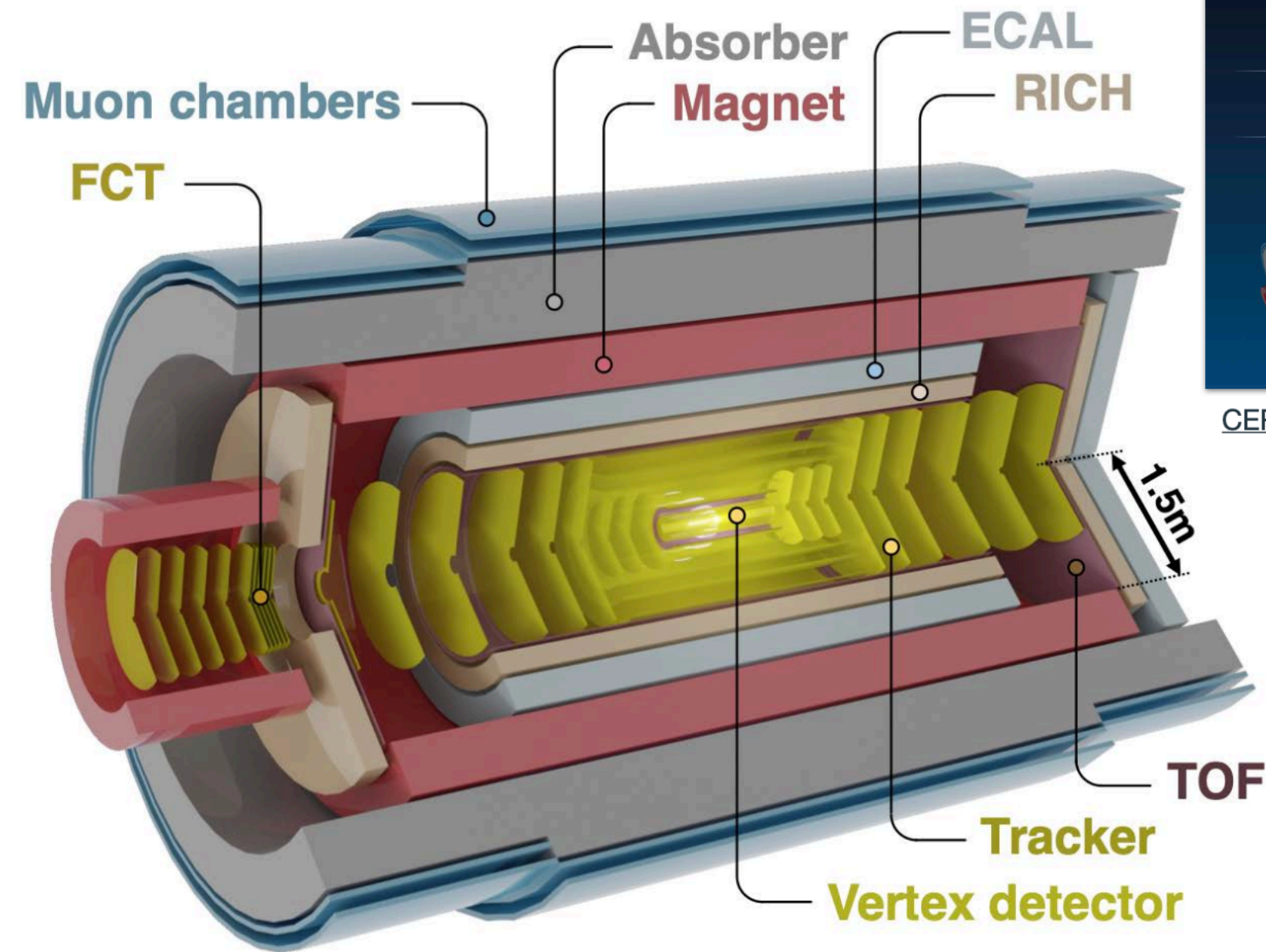
- Completely new experiment
  - ➔ Material budget: 0.1%  $X_0$  iris layer (other layers  $< 1\% X_0$ )
  - ➔ Rapidity coverage: up to **8** rapidity units
  - ➔ Go as close to the beam as possible
    - ➔ Improved Velo like solutions
  - ➔ Time measurements: outer layer  $\sim 20$  ps
    - ➔ More timing layers and different silicon pixel technologies considered







# ALICE 3 (2026-2036): Detector

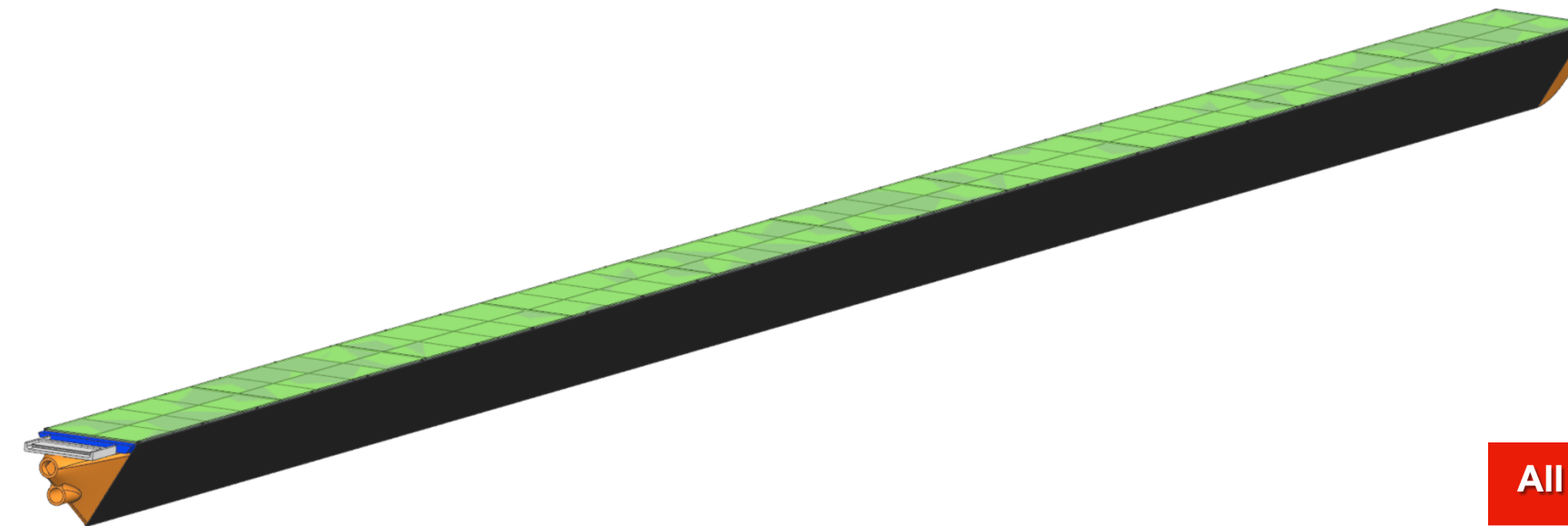


CERN-LHCC-2022-009

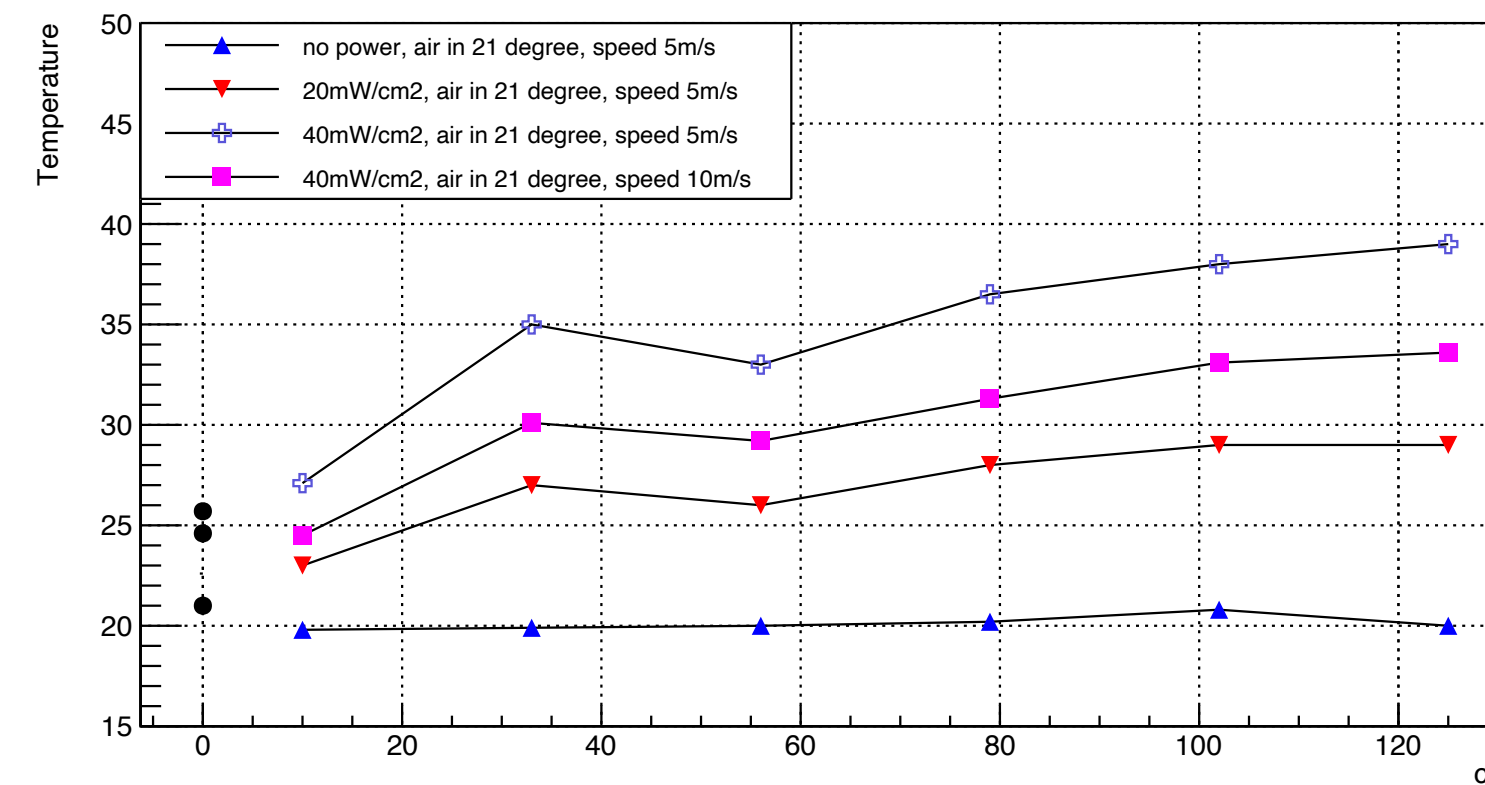
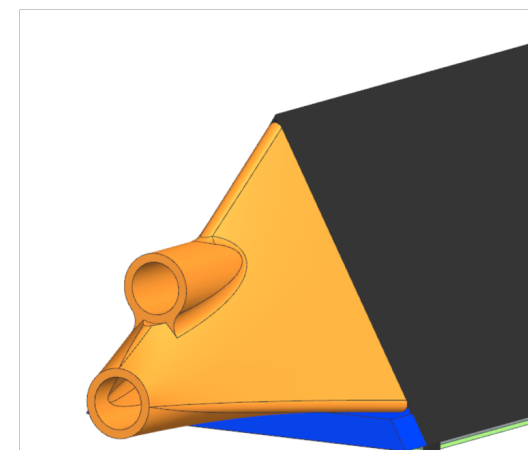
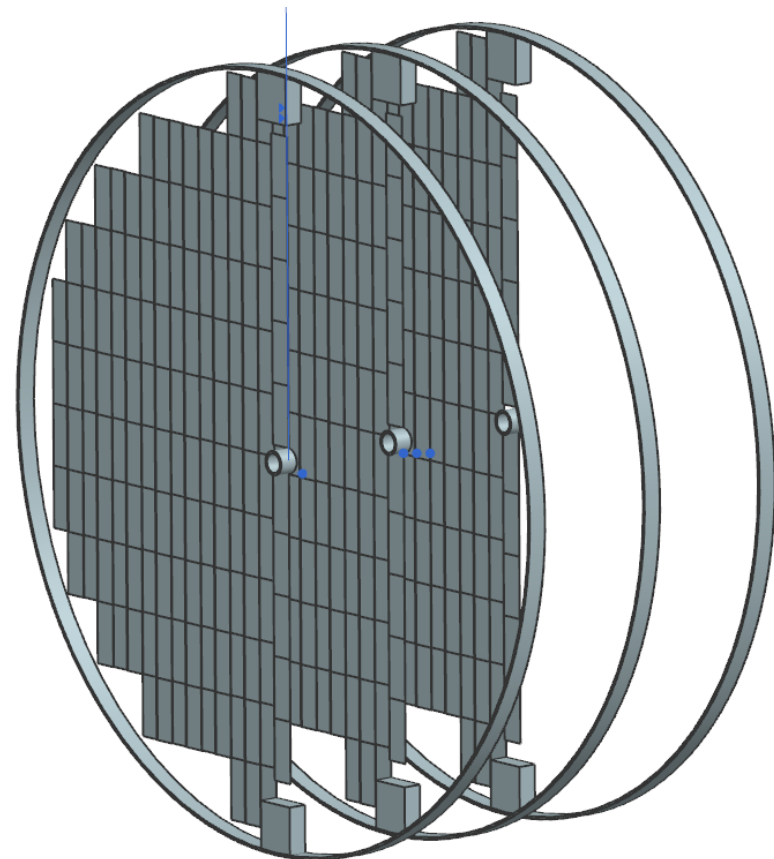
## What we do:

Major responsibility on the tracker forward disks

Main stakeholders in the project besides us: *Germany, Korea, France and Austria(?)*



All in all, concluding



► My job is to put the minimum physics requirement and that is a pointing resolution of 3-4 $\mu$ m at  $pT = 1$  GeV, and a momentum resolution at 1% or better, this translates in mechanical structures + cooling < 1%  $X_0$

► You are completely free to tell me how (even because I have no idea :))





## Develop algorithms for low- $p_T$ tracking in dense environment driven by physics requirements

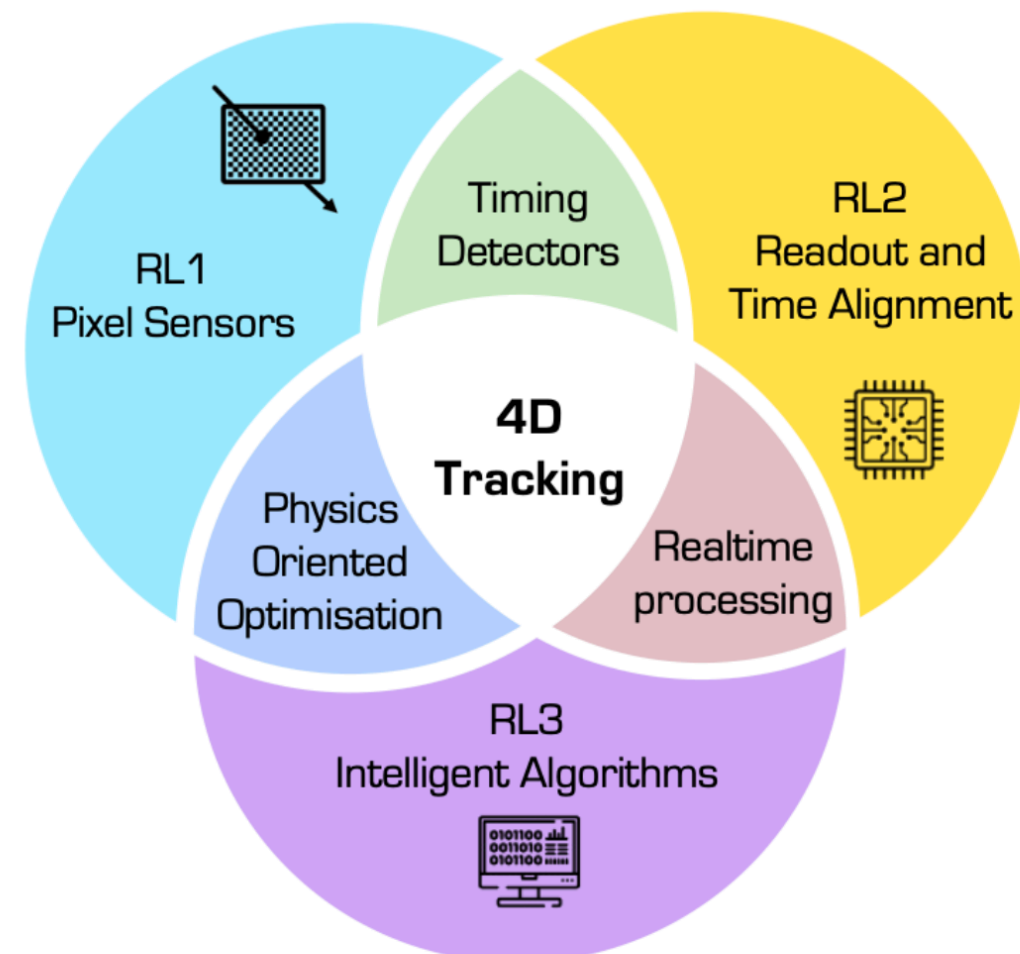
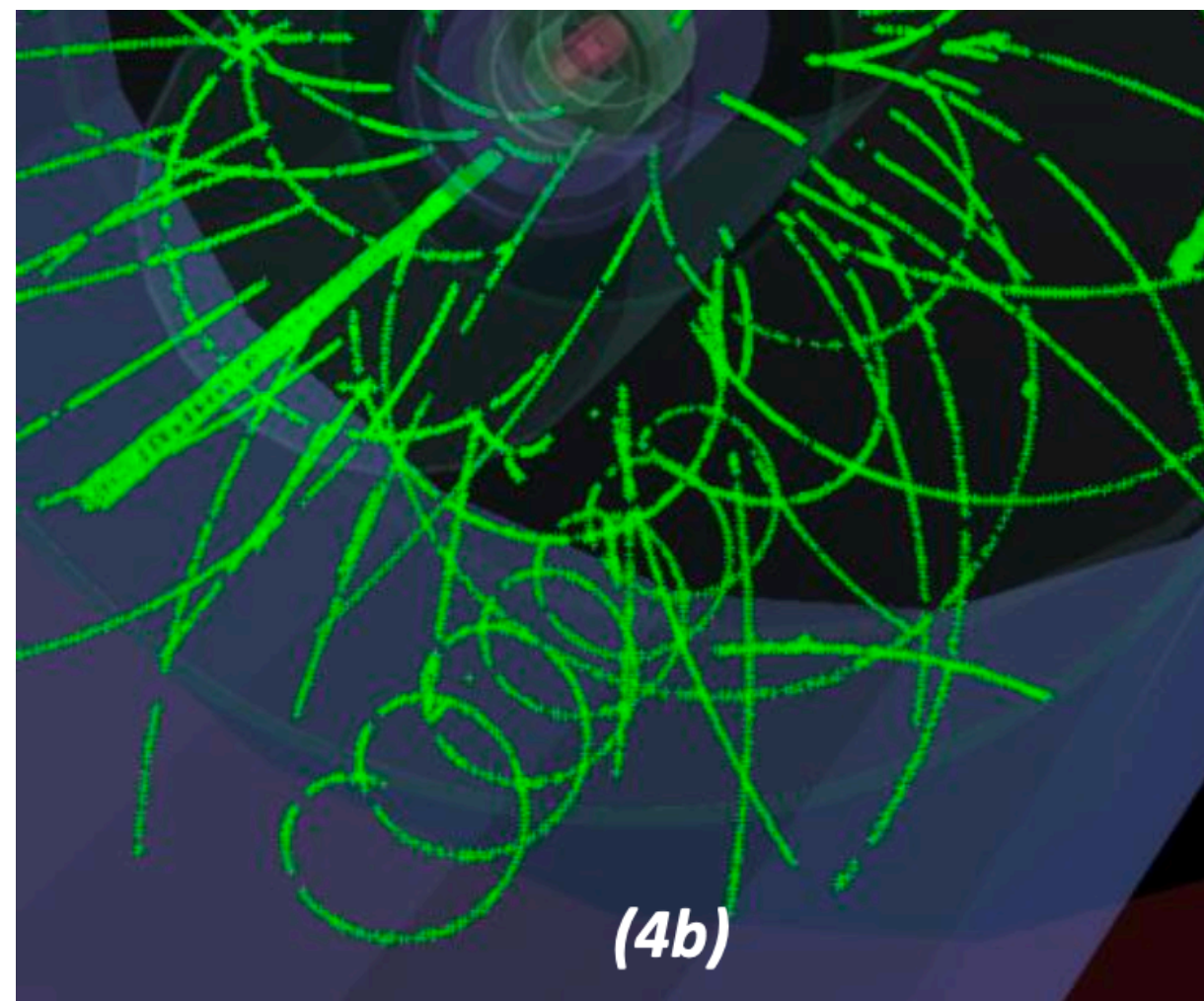
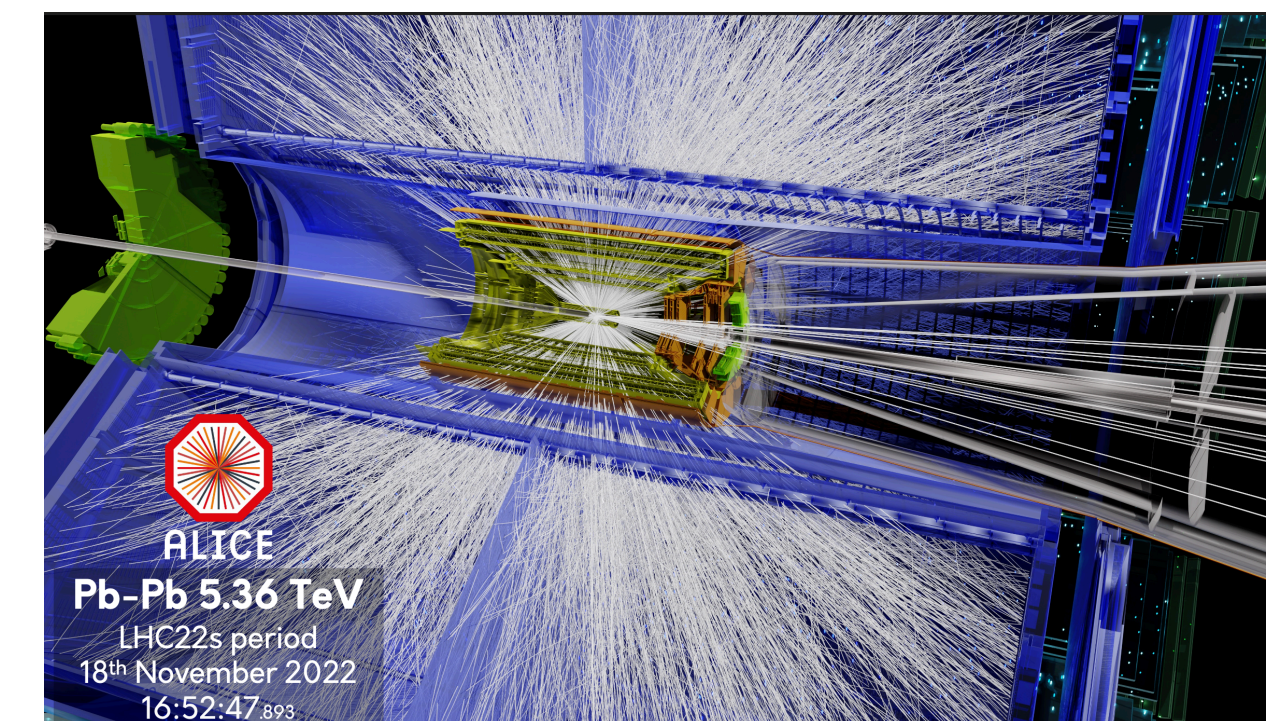
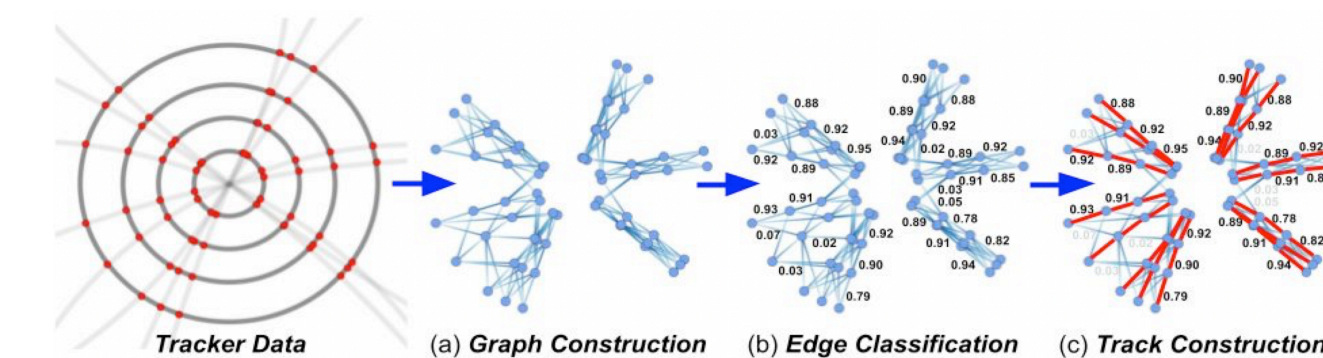


Figure 5: Interplay between the research lines.



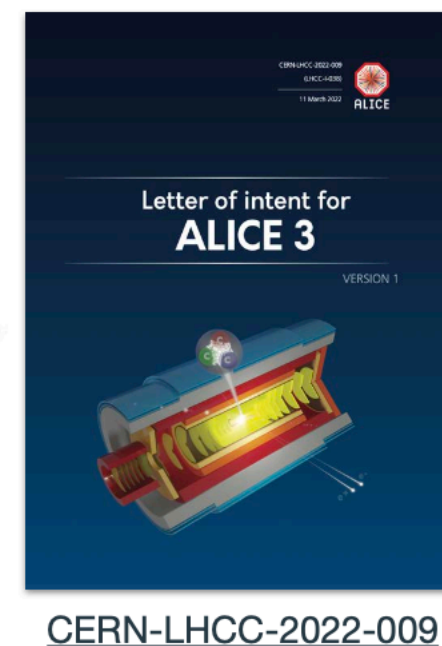
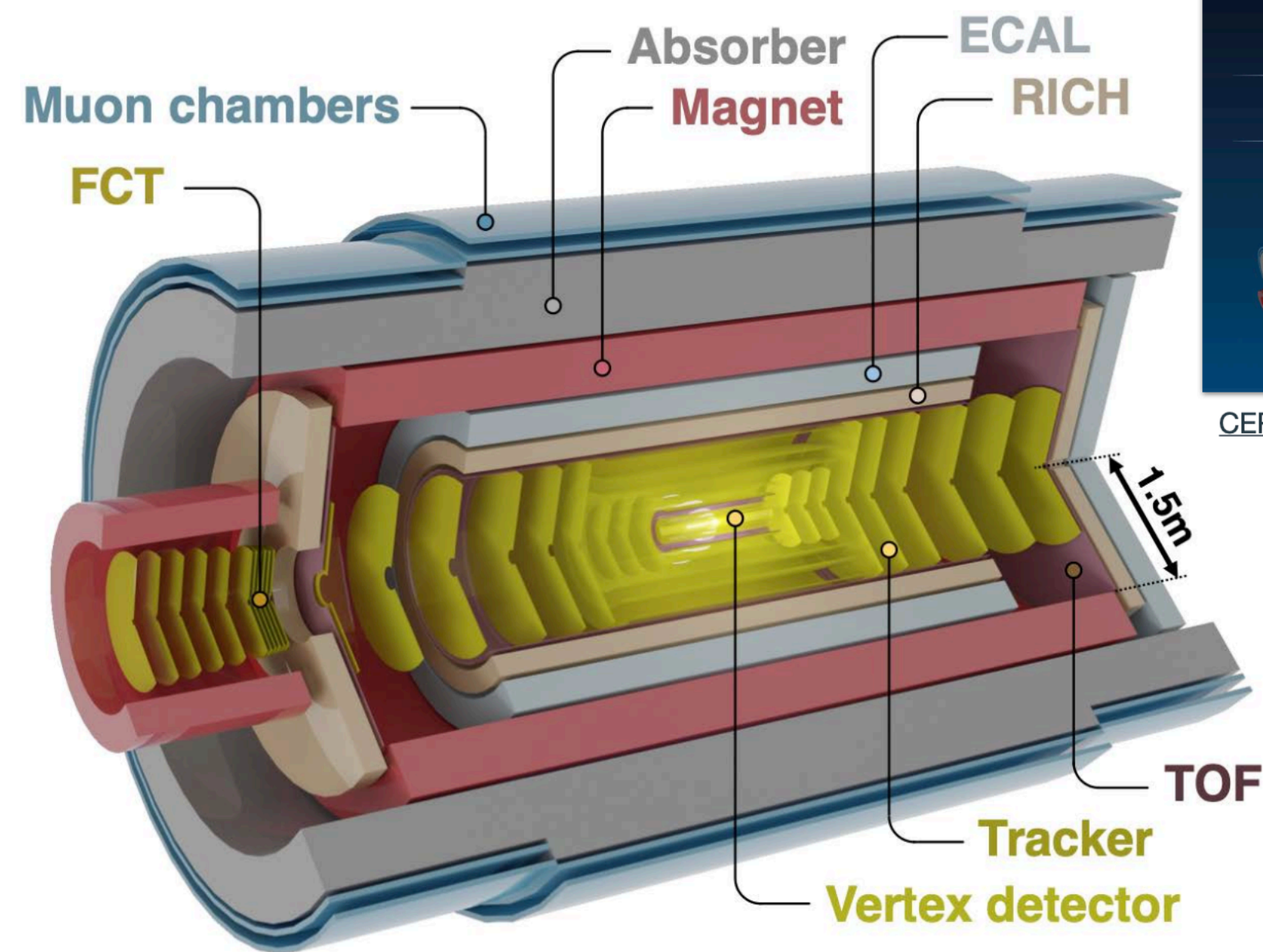
- Development of ACTS-based track reconstruction framework for ALICE 3
  - ➔ Evaluation and optimization of physics and computing performance
  - ➔ Investigate ML-based approaches for track reconstruction
  - ➔ 4D tracking and vertexing
- Tracking software leading role
  - ➔ Strengthen links with CERN tracking and computing experts
  - ➔ Hosting ACTS-related meetings (April first one at Nikhef)
- HPC & accelerated tracking
  - ➔ GPUs (consumer grade and data-center class)
  - ➔ FPGAs for low-latency or energy-efficient parts







# ALICE 3 (2026-2036): a bird's-eye view



## High level milestones:

- Mechanics: stave-like structures with integrated cooling and ring support - R&D, Design toward TDR and, later, (part of) production - *key partners: France, Germany, Korea, Austria*
- Sensor design/characterisation and powering (responsible of TDR chapter on powering) *key partners: CERN, France*
- Readout/DAQ: ALICE specific firmware for FELIX, setups *key partners: CERN, France, Germany*
- Commissioning and installation *key partners: CERN, France, Germany*
- Tracking: Integration of ACTS in ALICE, 4D tracking, AI tracking *key partners: CERN, ALICE Coll, ....*

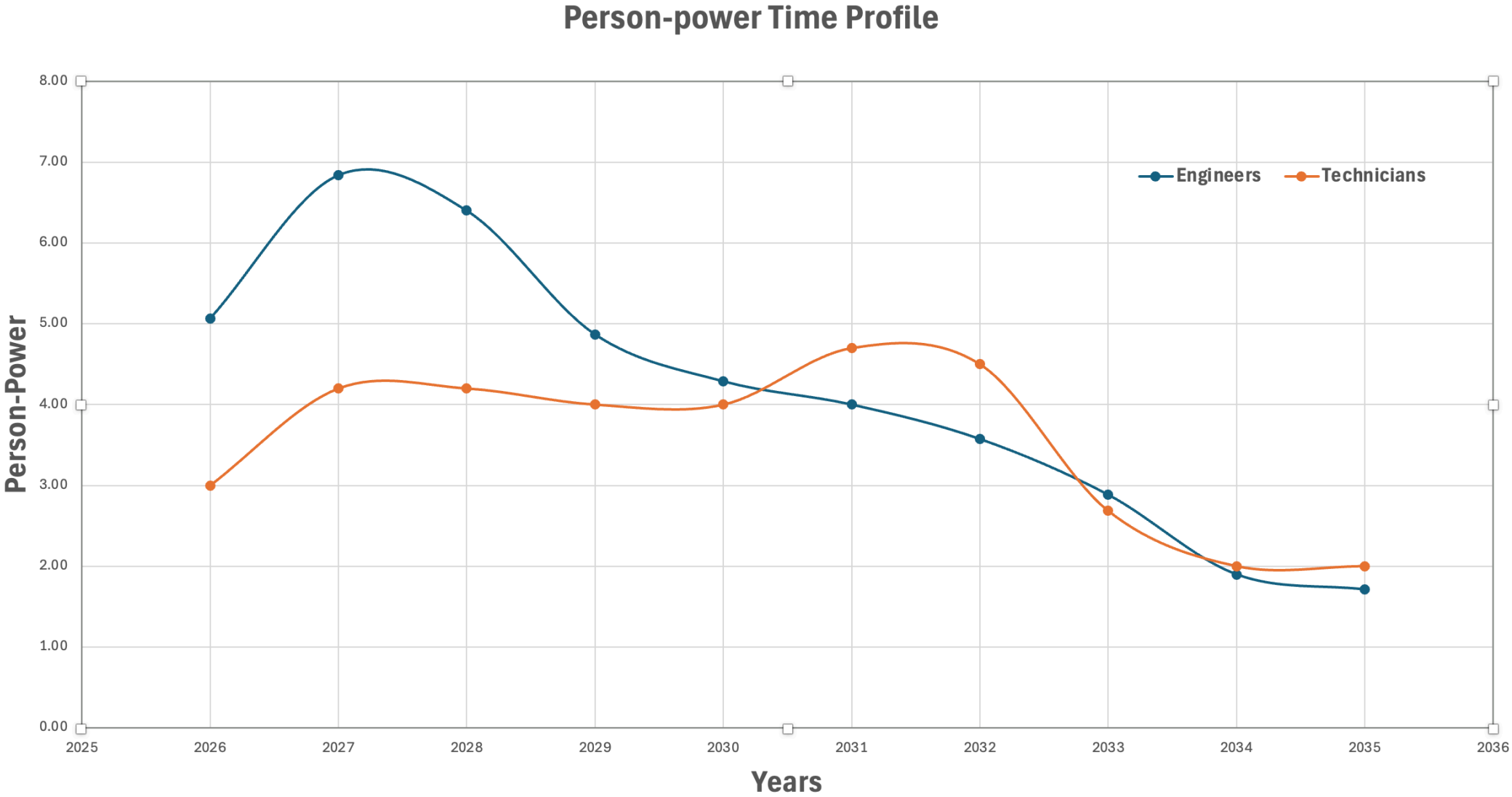




# FASTTRACK: Personpower



			WP1 Sensors						WP2 ASICs				WP3 Readout				WP3 Mechanics & Cooling						WP5 IT Infrastructure, Data & Software				Partial Totals Material	Partial Totals Personnel	Total Material	Total Personnel	
			WP1.1 3D Hybrids Material	WP1.1 3D Hybrids Personnel	WP1.3 LGAD Hybrids Material	WP1.3 LGAD Hybrids Personnel	WP1.2 Monolithic Material	WP1.2 Monolithic Personnel	WP2.2 Monolithic Material	WP2.2 Monolithic Personnel	WP2.1 Hybrid ASICs Material	WP2.1 Hybrid ASICs Personnel	WP3.1 High-Speed Transmission Material	WP3.1 High-Speed Transmission Personnel	WP3.2 Data Acquisition Material	WP3.2 Data Acquisition Personnel	WP4.1 Module Construction Material	WP4.1 Module Construction Personnel	WP4.2 Cooling Material	WP4.2 Cooling Personnel	WP4.3 Mechanics & Infrastructure Material	WP4.3 Mechanics & Infrastructure Personnel	WP5.1 Accelerators Material	WP5.1 Accelerators Personnel	WP5.2 Algorithms Material	WP5.2 Algorithms Personnel					
ALICE	Detector	Sensor					0.3																					3.8	8	8.1	9
		Mechanics												0.2	1			0.3	1	1.2	3										
		Module Assembly												0	0			0.3	0	0.2											
		Cooling																0.3													
		Readout Power												0.3	1	0.7	1					0									
	Common Funds	Common Funds					0.5								0.5							0.25			0.25		1.5	0			
	R&D	Sensor Submission Costs					1																					2.3	0		
		Characterisation					0.4		0.4																						
		R&D														0.1		0.2				0.2									
	Computing	Computing																						0.25		0.25	1	0.5	1		
				0		0		0		0		0		2		1		1		1		3		0		1					



To contribute our share to building this detector requires a significant investment

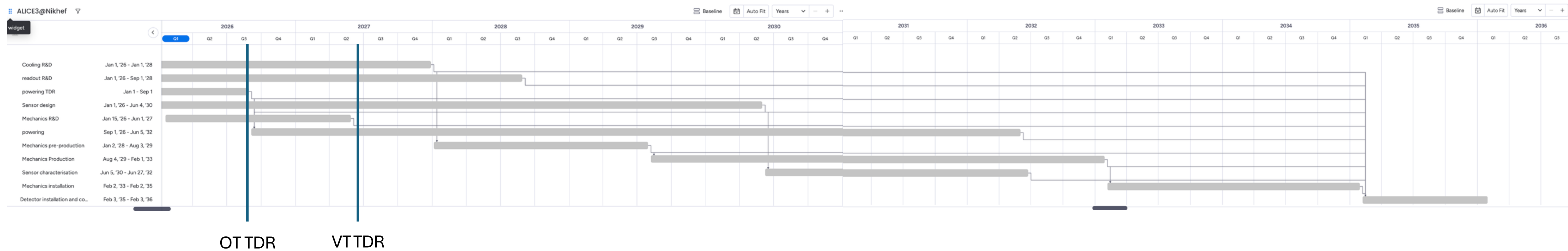




# ALICE 3 (2026-2034): Personpower

		Optional											
Deliverable Type	FASTTRACK WP	Cost (MEUR)	Q2/2026-Q1/2027	Q2/2027-Q1/2028	Q2/2028-Q1/2029	Q2/2029-Q1/2030	Q2/2030-Q1/2031	Q2/2031-Q1/2032	Q2/2032-Q1/2033	Q2/2033-Q1/2034	Q2/2034-Q1/2035	Q2/2035-Q1/2036	
MoU	WP1.2 Monolithic	0.300	5.300										
MoU	WP3.1 High-Speed Transmission	0.200											
MoU	WP4.1 Module Construction	0.300											
MoU	WP4.2 Cooling	0.300											
MoU	WP4.3 Mechanics & Infrastructure	1.200				0.5MT.E+2MT.D	0.3MT.E+2MT.D+0.3MT.F	0.2MT.E+2MT.D+0.5MT.F	2MT.D+0.2MT.E+1MT.F	1.5MT.D+1MT.F	1MT.D+0.5MT.F	1MT.D	
MoU	WP4.1 Module Construction	0.200											
MoU	WP4.2 Cooling	0.300											
MoU	WP2.2 Monolithic	0.000											
MoU	WP3.1 High-Speed Transmission	0.300											
MoU	WP3.2 Data Acquisition	0.700											
MoU-CF	WP1.2 Monolithic	0.500					1ET.E	1ET.E+0.5ET.A	1ET.E+0.5ET.A	1ET.E	1ET.E	1ET.E	1ET.E
MoU-CF	WP3.2 Data Acquisition	0.500											
MoU-CF	WP4.3 Mechanics & Infrastructure	0.250											
MoU-CF	WP5.2 Algorithms	0.250											
R&D	WP1.2 Monolithic	1.000	2.800	0.5ET.E+0.5ET.A	0.5ET.A+0.7ET.E	0.5ET.A+1ET.E+0.2ET.B							
R&D	WP1.2 Monolithic	0.400		0.1MT.G	0.2MT.G	0.3MT.G	0.2MT.G	0.3MT.G	0.3MT.G	0.1MT.G	0.1MT.G	0.1MT.G	
R&D	WP2.2 Monolithic	0.400											
R&D	WP1.2 Monolithic,WP2.2 Monolithic	0.000		0.7ET.C + 0.3ET.D	1ET.C+0.5ET.D	0.5ET.C+0.5ET.D	0.3ET.C+0.4ET.D						
R&D	WP3.2 Data Acquisition	0.100											
R&D	WP4.1 Module Construction	0.200											
R&D	WP4.3 Mechanics & Infrastructure	0.200		1MT.E+0.5MT.A/B+1MT.D	1MT.E+1MT.A/B+1MT.D	1MT.E+1MT.A/B+1.5MT.D							
R&D	WP5.1 Accelerators , WP5.2 Algorithms	0.500				0.5CT.C	0.5CT.C	0.5CT.C	0.5CT.C	0.5CT.C	0.5CT.C		
Contingency	All WP's	0.530	1.060										
Contingency	All WP's	0.530											
		8.100											

MT.A	Simulation studies
MT.B	Studies of Thermodynamics & Heat Transfer
MT.C	Materials Science & Engineering
MT.D	Manufacturing & Production
MT.E	Design & Drafting
MT.F	Control Systems & Mechatronics
MT.F	Control Systems & Mechatronics
ET.A	Analog electronics design (frontends, RF, advanced PCB's)
ET.B	Digital electronics design (DAQ)
ET.C	Analog IC design
ET.D	Digital IC design
ET.E	Technical support (cables/mechatronics/integration etc)
CT.A	Software engineering for embedded or data acquisition
CT.B	Software engineering for control systems (SCADA)
CT.C	Software engineering for analysis frameworks /simulations
CT.D	System administration and network administration support







# Project or Projects?

- ▶ Historically ALICE has been treated, OPP and Nikhef wise, as a single project, independently from the size of it.
- ▶ This time it is probably better, for OPP and management purposes, to separate ALICE3 in **two sub-projects**: “Mechanics” and “Electronic and design”  
*May be 2+1 adding (4D/Al) low-pt tracking (around 2029) as a standalone project*
- ▶ Keep in mind ITS3 is still running so it would mean 3 projects and relative codes for ALICE@OPP

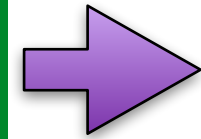




# Concluding: The idea in a slide

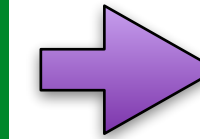
## 1) Detector

- Focus efforts that are coherent with Nikhef vision and that grant maximum visibility with > 2036 in mind



## 2) Tracking

- Focus on ALICE unique capability, i.e (4D/AI) tracking down to tenth of MeV  
-> Complementary physics reach with respect CMS and ATLAS



## 3) Physics exploitation (>2036)

- Leverage on 1) and 2) for strong positioning in heavy-flavour physics, electromagnetic probes with an eye on beyond standard model possibilities